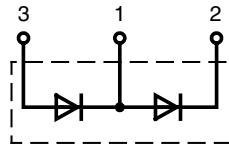


High Power Diode Modules

I_{FRSM} = 2x 450 A
I_{FAVM} = 2x 290 A
V_{RRM} = 1200-1600 V

V _{RSM} V	V _{RRM} V	Type
1300	1200	MDD 250-12N1
1500	1400	MDD 250-14N1
1700	1600	MDD 250-16N1



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Symbol	Conditions	Maximum Ratings		
I _{FRMS}	T _{VJ} = T _{VJM}	450	A	
I _{FAVM}	T _C = 100°C; 180° sine	290	A	
I _{FSM}	T _{VJ} = 45°C; t = 10 ms (50 Hz) V _R = 0 t = 8.3 ms (60 Hz)	11	kA	
	T _{VJ} = T _{VJM} ; t = 10 ms (50 Hz) V _R = 0 t = 8.3 ms (60 Hz)	9	kA	
		11,7	kA	
I ² t	T _{VJ} = 45°C; t = 10 ms (50 Hz) V _R = 0 t = 8.3 ms (60 Hz)	605	kA ² s	
	T _{VJ} = T _{VJM} ; t = 10 ms (50 Hz) V _R = 0 t = 8.3 ms (60 Hz)	405	kA ² s	
		560	kA ² s	
		380	kA ² s	
T _{VJ}		-40...+150	°C	
T _{VJM}		150	°C	
T _{stg}		-40...+125	°C	
V _{ISOL}	50/60 Hz, RMS t = 1 min I _{ISOL} ≤ 1 mA t = 1 s	3000	V~	
		3600	V~	
M _d	Mounting torque (M5) Terminal connection torque (M8)	2.5 - 5	Nm	
		12 - 15	Nm	
Weight	Typical including screws	320	g	

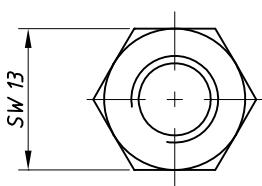
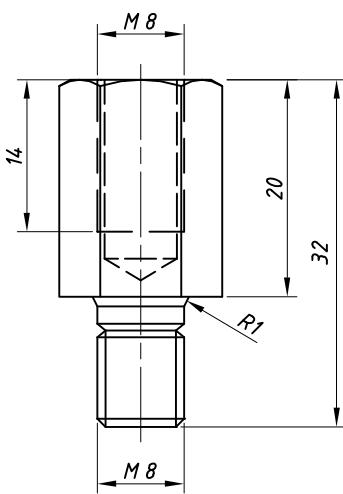
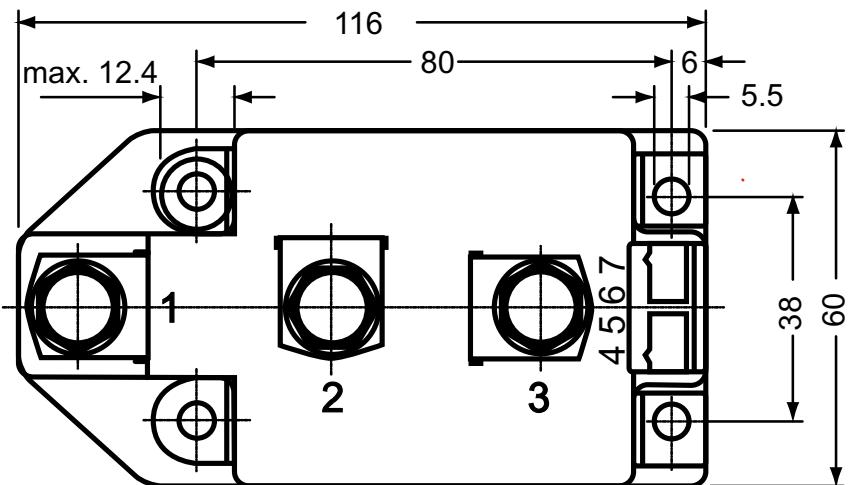
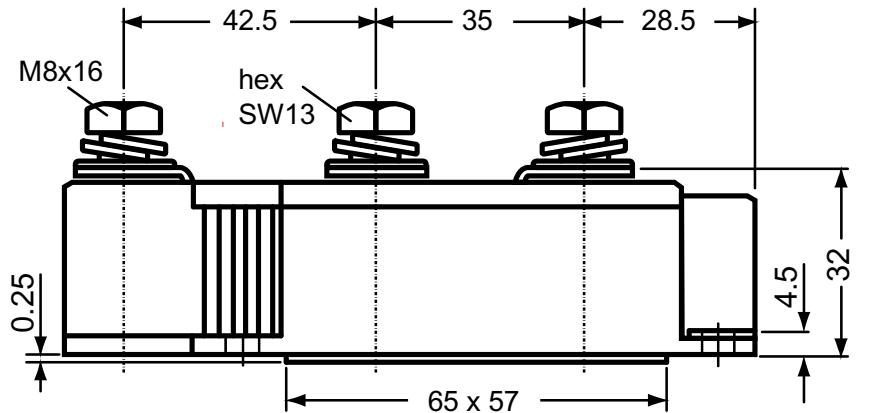
Symbol	Conditions	Characteristics Values		
I _{RRM}	V _R = V _{RRM} ; T _{VJ} = T _{VJM}	40	mA	
V _F	I _F = 600 A; T _{VJ} = 25°C	1.3	V	
V _{TO}	For power-loss calculations only	0.75	V	
r _t	T _{VJ} = T _{VJM}	0.75	mΩ	
R _{thJC}	per diode; DC current	0.129	K/W	
	per module	0.065	K/W	
R _{thJK}	per diode; DC current	0.169	K/W	
	per module	0.0845	K/W	
Q _S	T _{VJ} = 125°C; I _F = 400 A; -di/dt = 50 A/μs	760	μC	
I _{RM}		275	A	
d _s	Creeping distance on surface	12.7	mm	
d _A	Creepage distance in air	9.6	mm	
a	Maximum allowable acceleration	50	m/s ²	

Data according to IEC 60747 and refer to a single diode unless otherwise stated.

IXYS reserves the right to change limits, test conditions and dimensions.

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Dimensions in mm (1 mm = 0.0394")



Threaded spacer for higher Anode /
Cathode construction:

Type **ZY 250** (material brass)

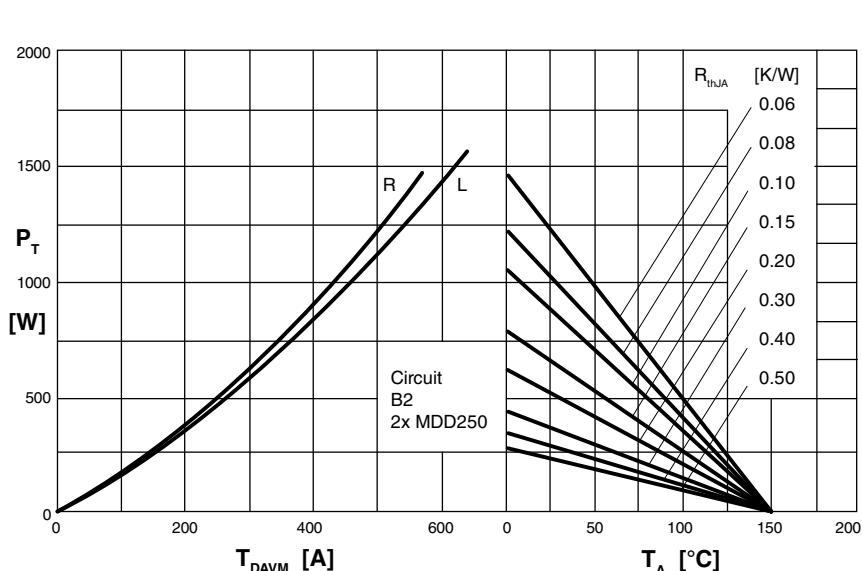
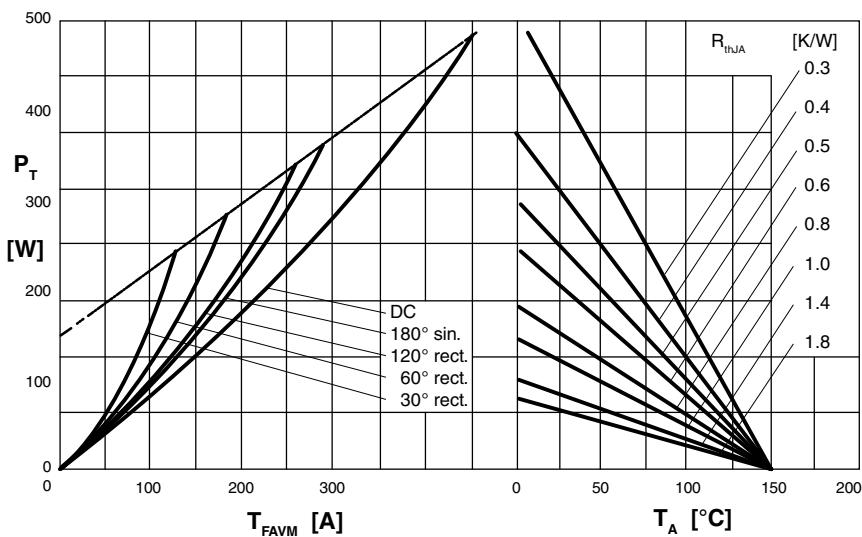
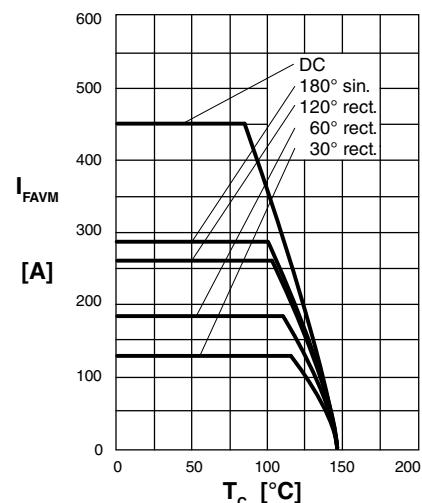
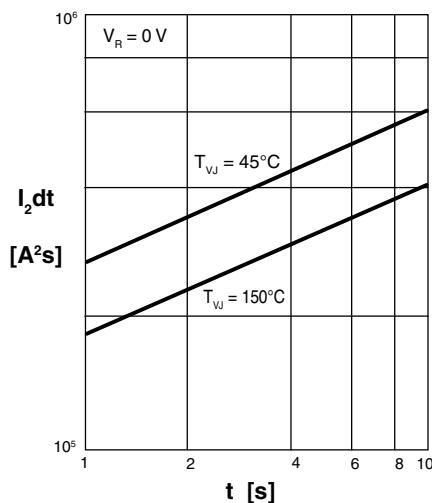
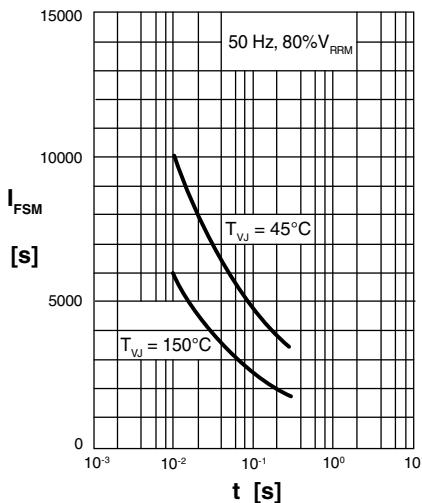


Fig. 4 Single phase rectifier bridge: Power dissipation vs. direct output current and ambient

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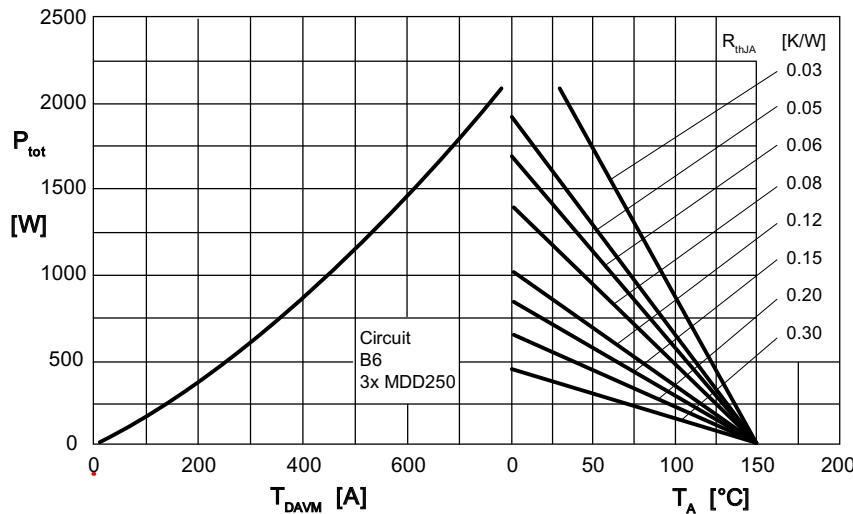


Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

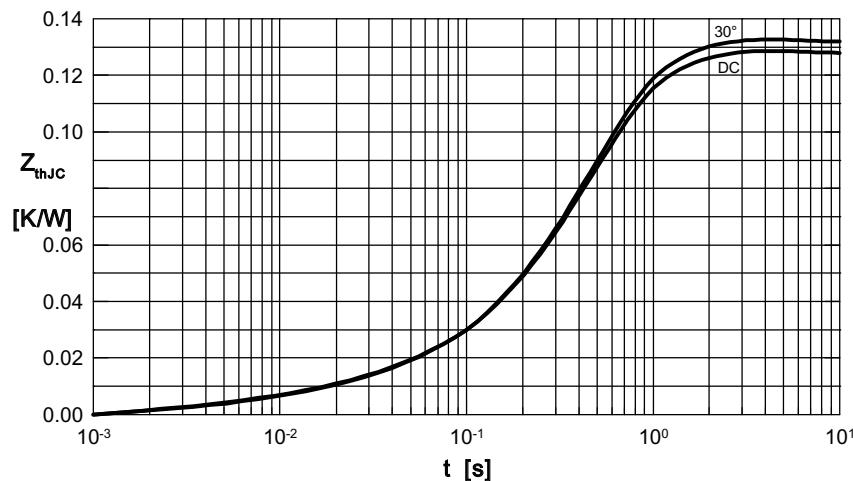


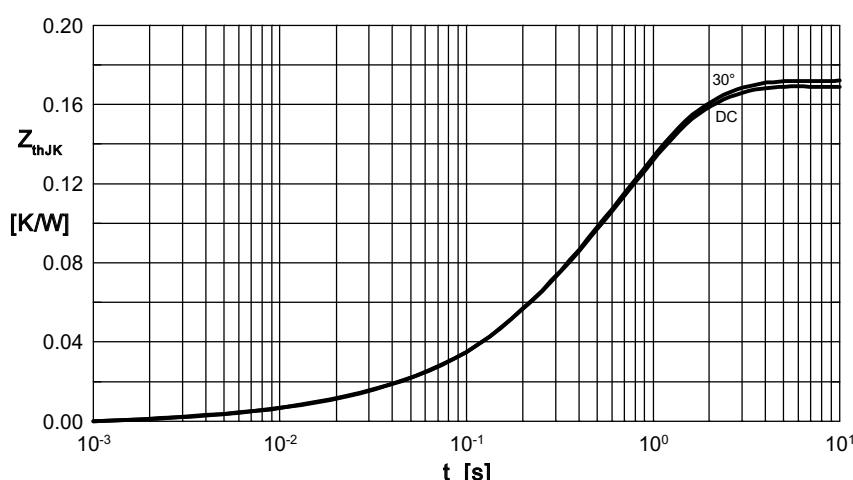
Fig. 7 Transient thermal impedance junction to case (per diode)

R_{thJC} for various conduction angles d:

d	R_{thJC} [K/W]
DC	0.129
180°	0.131
120°	0.132
60°	0.132
30°	0.133

Constants for Z_{thJC} calculation:

i	R_{thi} [K/W]	t_i [s]
1	0.0035	0.0099
2	0.0165	0.168
3	0.1091	0.456



R_{thJK} for various conduction angles d:

d	R_{thJK} (K/W)
DC	0.169
180°	0.171
120°	0.172
60°	0.172
30°	0.173

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0035	0.0099
2	0.0165	0.168
3	0.1091	0.456
4	0.04	1.36

Fig. 8 Transient thermal impedance junction to heatsink (per diode)